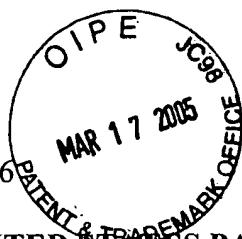


Docket No.: 056937-0086



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Customer Number: 20277
Kiyohito MUKAI, et al. : Confirmation Number: 3812
Application No.: 10/663,642 : Group Art Unit: 2812
Filed: September 17, 2003 : Examiner: Not yet assigned
For: METHOD OF FABRICATING A SEMICONDUCTOR DEVICE

INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In accordance with the provisions of 37 C.F.R. 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached form PTO-1449. It is respectfully requested that the references be expressly considered during the prosecution of this application, and that the references be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

This Information Disclosure Statement is being filed within three months of the U.S. filing date OR before the mailing date of a first Office Action on the merits. No certification or fee is required.

Each non-English language reference was first cited in a corresponding foreign application search report or office action and its relevance discussed therein. A copy of the foreign search report or office action, is attached for the Examiner's information.

Please charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account 500417 and please credit any excess fees to such deposit account.

Respectfully submitted,

McDERMOTT WILL & EMERY LLP

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**Please recognize our Customer No. 20277
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Date: March 17, 2005



SHEET 1 OF 1

| INFORMATION DISCLOSURE CITATION IN AN APPLICATION (PTO-1449) | | | ATTY. DOCKET NO. 056937-0086 | | SERIAL NO. 10/663,642 | |
|--|----------|---|--|--|--|---|
| | | | APPLICANT Kiyohito MUKAI, et al. | | | |
| | | | FILING DATE September 17, 2003 | | GROUP 2812 | |
| U.S. PATENT DOCUMENTS | | | | | | |
| EXAMINER'S INITIALS | CITE NO. | Document Number Number-Kind Code ₂ (<i>if known</i>) | Publication Date MM-DD-YYYY | Name of Patentee or Applicant of Cited Document | | Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear |
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| EXAMINER'S INITIALS | CITE NO. | Foreign Patent Document Country Codes-Number 4-Kind Codes (<i>if known</i>) | Publication Date MM-DD-YYYY | Name of Patentee or Applicant of Cited Document | Pages, Columns, Lines Where Relevant Figures Appear | Translation Yes No |
| | | JP 10-022376 | 01/23/1998 | SAMSUNG ELECTRON CO LTD. | | ENGLISH ABSTRACT ONLY |
| | | JP 2000-232153 A | 08/22/2000 | SONY CORP. | | ENGLISH ABSTRACT ONLY |
| | | JP 2000-340567 A | 12/08/2000 | SEIKO EPSON CORP. | | ENGLISH ABSTRACT ONLY |
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